

Table of Contents



**FocalTech Systems
FT5446DQS
Capacitive Touch Controller**

Basic Functional Analysis

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Table of Contents

- 1 Introduction**
 - 1.1 Device Naming Conventions Used in this Report
 - 1.2 Device Samples Used for Analysis
 - 1.3 Company Profiles
 - 1.4 Executive Summary
 - 1.5 F5-132ATP Die Summary
 - 1.6 F5-134ATPBC Die Summary

- 2 Device Identification**
 - 2.1 Downstream Product
 - 2.2 FT5446DQS Package
 - 2.3 F5-132ATP Die
 - 2.4 F5-132ATP Die Features
 - 2.5 F5-134ATPBC Die
 - 2.6 F5-134ATPBC Die Features

- 3 Process Analysis**
 - 3.1 F5-132ATP Die Cross-Sectional Analysis
 - 3.2 F5-134ATPBC Die Cross-Sectional Analysis

- 4 Functional Layout Analysis**
 - 4.1 F5-132ATP Die Functional Layout Analysis
 - 4.2 F5-132ATP Die Functional Block Summary
 - 4.3 F5-134ATPBC Die Functional Layout Analysis
 - 4.4 F5-134ATPBC Die Functional Block Summary

- 5 Cost Analysis**
 - 5.1 F5-132ATP and F5-134ATPBC Manufacturing Cost Analysis

- 6 References**

- 7 Statement of Measurement Uncertainty and Scope Variation**

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List of Figures

Figure 2.1.1 ASUS ZE500CL ZenFone 2 Smartphone – Top
Figure 2.1.2 ASUS ZE500CL ZenFone 2 Smartphone – Bottom
Figure 2.1.3 ASUS ZE500CL ZenFone 2 Smartphone – Teardown Photograph
Figure 2.2.1 FT5446DQS Package Photograph – Top
Figure 2.2.3 FT5446DQS Package Photograph – Bottom
Figure 2.2.4 FT5446DQS Package X-Ray – Plan View
Figure 2.2.5 FT5446DQS Package X-Ray – Plan View Detail
Figure 2.2.6 FT5446DQS Package X-Ray – Side View
Figure 2.3.1 F5-132ATP Die Photograph
Figure 2.3.2 F5-132ATP Die Markings
Figure 2.3.3 F5-132ATP Die Photograph – Delayered to the Polysilicon Layer
Figure 2.4.1 F5-132ATP Die Corner
Figure 2.4.2 F5-132ATP Minimum Pitch Bond Pads
Figure 2.5.1 F5-134ATPBC Die Photograph
Figure 2.5.2 F5-134ATPBC Die Markings
Figure 2.5.3 F5-134ATPBC Die Photograph – Delayered to the Polysilicon Layer
Figure 2.6.1 F5-134ATPBC Die Corner
Figure 2.6.2 F5-134ATPBC Minimum Pitch Bond Pads
Figure 3.1.1 F5-132ATP General Structure – Logic
Figure 3.1.2 F5-132ATP Nonvolatile Memory
Figure 3.1.3 F5-132ATP Minimum Metal 1 Pitch
Figure 3.1.4 F5-132ATP Minimum Contacted Gate Pitch
Figure 3.2.1 F5-134ATPBC General Structure – Logic
Figure 3.2.2 F5-134ATPBC Minimum Metal 1 Pitch
Figure 3.2.3 F5-134ATPBC Minimum Contacted Gate Pitch
Figure 4.1.1 F5-132ATP Functional Blocks at the Polysilicon Layer
Figure 4.3.1 F5-134ATPBC Functional Blocks at the Polysilicon Layer

List of Tables

Table 1.2.1 FT5446DQS Component Summary
Table 1.5.1 F5-132ATP Die Summary
Table 1.5.2 F5-132ATP Observed Critical Dimensions
Table 1.6.1 F5-134ATPBC Die Summary
Table 1.6.2 F5-134ATPBC Observed Critical Dimensions
Table 4.2.1 F5-132ATP Functional Block Summary
Table 4.4.1 F5-134ATPBC Functional Block Summary
Table 5.1.1 F5-132ATP and F5-134ATPBC Manufacturing Cost Characteristics
Table 5.1.2 F5-132ATP and F5-134ATPBC Manufacturing Costs

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